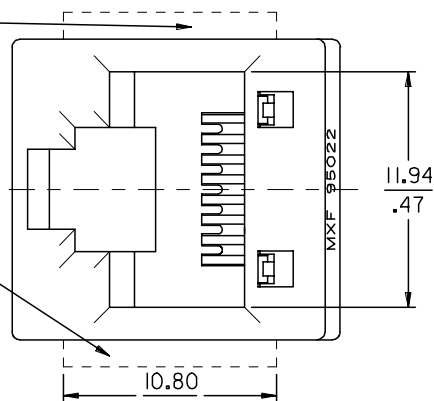
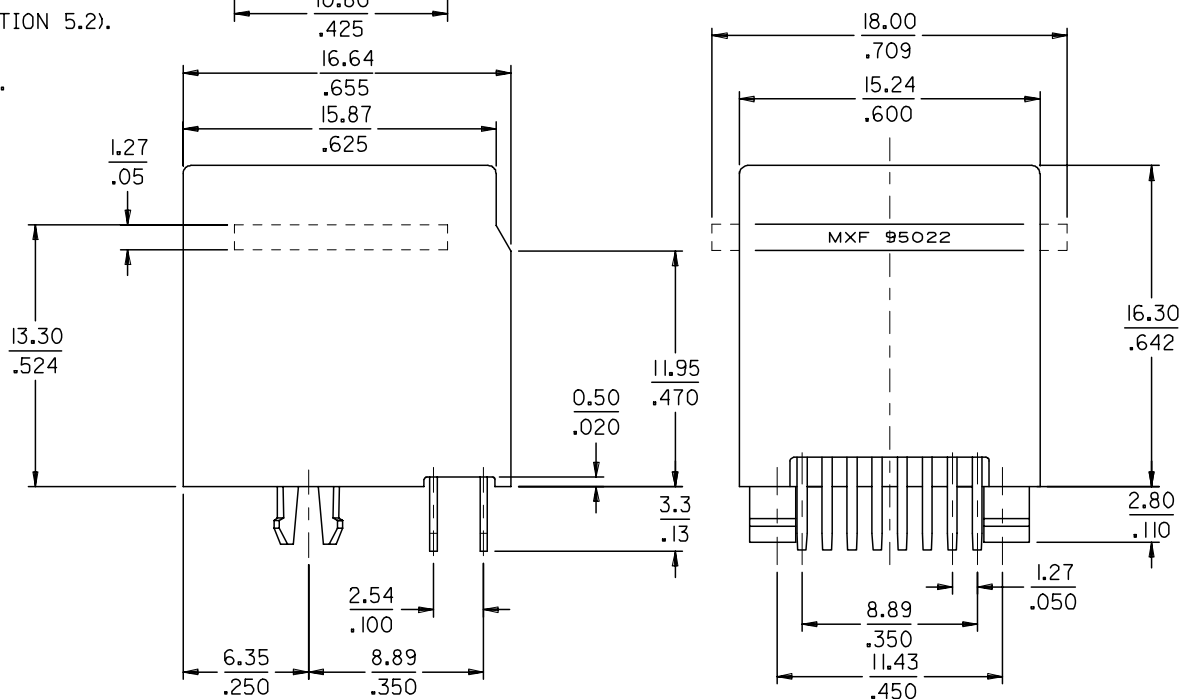


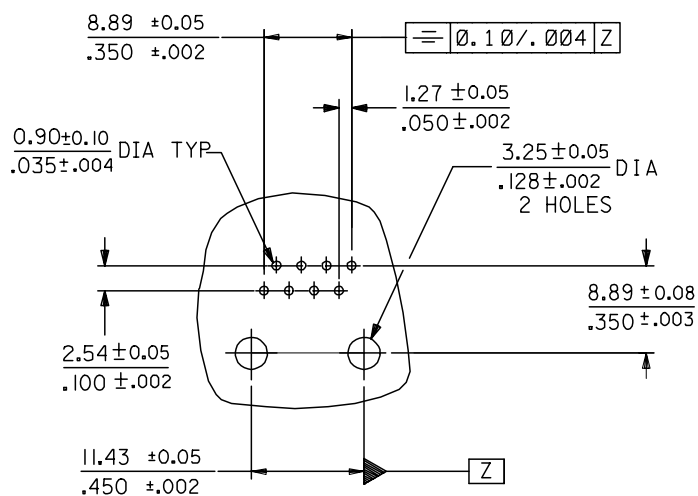
2- JACK FOR MATING WITH F.C.C. 68 PLUGS (90075 MOLEX SERIES).
3- PRODUCT SPECIFICATION PS-95003 AND PS-85505 (SECTION 5.2).
4- APPLICATION SPECIFICATION AS-95001.
5- PACKAGING SPECIFICATION PK-95022 (TRAY PACKAGING).
6- EXCEEDS CATEGORY 5E PERFORMANCE.
7- PC BOARD THICKNESS: 1.57/.062



JACK WITHOUT RIBS
MATERIAL NR.: 85506-0002



P.C.B. MOUNTING PATTERN
(see from component side)



SCALE 2:1

ENTER DESCRIPTION EC NO: MG2005-0147 DRAWN: CSEBASTI CHKD: FCARABET APPR: S.KNOLLER			2004/10/21 2004/10/22 2004/11/04			DESCRIPTION			QUALITY SYMBOLS ▽=0 ▽=0			GENERAL TOLERANCES (UNLESS SPECIFIED)				DIMENSION STYLE MM/IN				SCALE 4:1		DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
												mm		INCH		DRAWN BY FB		DATE 98/02/25		TITLE HIGH SPEED MODULAR JACK HIGH PROFILE TOP ENTRY THROUGH HOLE 8 CIRCUIT					
												3 PLACES ± --- ± ---		± .006		CHECKED BY		DATE							
												2 PLACES ± 0.15 ± .010				APPROVED BY		DATE							
												1 PLACE ± 0.25 ± ---								molex MOLEX INCORPORATED					
ANGULAR ± 2 °								MATERIAL NO.		DOCUMENT NO. SD-85506-001				SHEET NO. 1 OF 1											
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS						SEE CHART						THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION													

NOTES :

1- MATERIAL:

-HOUSING: LCP FIBER GLASS FILLED UL 94-V0 , COLOR BLACK.

-TERMINAL: PHOSPHOR BRONZE

PLATING :

BASE FINISH: NICKEL

CONTACT SURFACE FINISH:

GOLD,

OR

GOLD FLASH OVER PALLADIUM NICKEL.

EXCEEDS PRODUCT REQUIREMENTS BASED ON PS-85506-001

2- JACK FOR MATING WITH IEC 60603-7 AND TIA-1096-A (90075 MOLEX SERIES).

3- PRODUCT SPECIFICATION PS-85506-001

4- PACKAGING SPECIFICATION PK-95022 (TRAY PACKAGING).

5- EXCEEDS CATEGORY 5E PERFORMANCE.

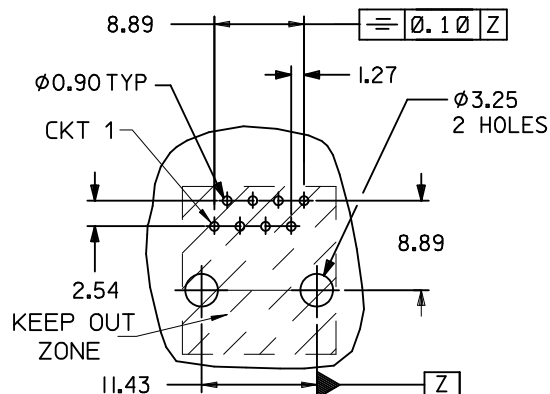
6- PC BOARD THICKNESS: 1.57

7- MANUFACTURING I.D. CAN BE MG, MXF OR MXI.

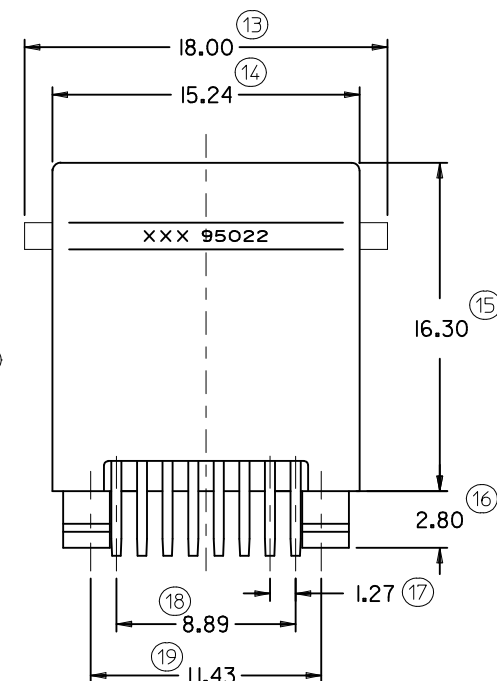
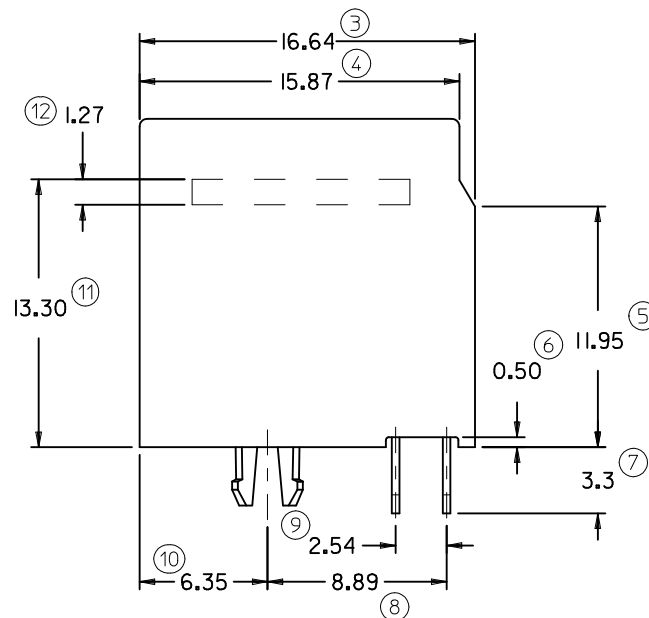
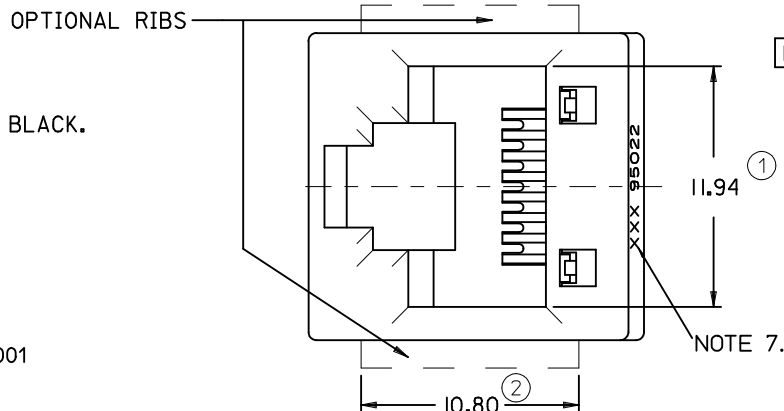
8- APPLICATION SPECIFICATION: AS-85513-001

LAST INSPECTION NUMBER: 19

P.C.B. MOUNTING PATTERN
(see from component side)
ALL DIMENSIONS REF DIMENSIONS



SCALE 2:1



	JACK WITH RIBS	JACK WITHOUT RIBS
MATERIAL No.	85506-5001	85506-5002

REMOVED PLATING OPTION EC NO: IPG2012-0620 DRWN:DBYRNES 2012/04/03 CHKD:MSHANAN 2012/04/17 APPR:EFOLAN 2012/06/28	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
						DRAWN BY FB		DATE 98/02/25	TITLE HIGH SPEED MODULAR JACK HIGH PROFILE TOP ENTRY THROUGH HOLE 8 CIRCUIT MOLEX INCORPORATED		
						CHECKED BY MF		DATE 1998/02/26			
						APPROVED BY FB		DATE 1998/02/28			
						MATERIAL NO. SEE CHART		DOCUMENT NO. SD-85506-501			SHEET NO. 1 OF 1
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			